

**IN THE CLAIMS:**

Please amend the claims as indicated herein.

1. (Currently Amended) A chassis for limiting electromagnetic interference from and dissipating heat generated by computer components within a computer, the chassis comprising:

a panel on a side of the chassis, the panel having an opening; and  
a mesh screen attached to the panel and covering the opening, the mesh screen suitable for blocking electromagnetic interference emissions from computer components within the chassis, wherein the computer components are visible from outside the computer through the mesh screen.

2. (Original) The chassis of claim 1, wherein the computer chassis is a chassis for a small form factor computer.

3. (Original) The chassis of claim 1, wherein the mesh screen comprises a thermally conductive material.

4. (Original) The chassis of claim 3, wherein the mesh screen comprises a metal.

5. (Original) The chassis of claim 1, wherein the mesh screen is attached to the panel by screws.

6. (Original) The chassis of claim 1, wherein the mesh screen has a gauge of at least 200 dots per square inch.

7. (Original) The chassis of claim 1, wherein the opening in the panel has a rectangular shape and comprises at least one half the area of the panel.

8. (Original) The chassis of claim 7, wherein the mesh screen is secured to the panel on the chassis by a screw near each corner of the rectangular opening around the mesh screen mounted to an interior side of the panel.

9. (Canceled)

10. (Currently Amended) A method of limiting electromagnetic interference from and dissipating heat generated by computer components within a computer chassis having a porous window, the method comprising the steps:

directing air flow from within the chassis out of the chassis through the

window, thereby cooling the computer components; and

preventing electromagnetic interference emissions generated by the computer

components from escaping the chassis through the window by

blocking the emissions with the window, wherein the computer

components are visible from outside the computer chassis through the

window.

11. (Original) The method of claim 10, wherein the chassis is a chassis for a small form factor computer.

12. (Canceled)

13. (Currently Amended) The method of claim 10, wherein the porous window has a hole density of at least 200 per square inch.